




Dual INT-A-PAK Low Profile “Half Bridge” (Trench PT IGBT), 400 A

Proprietary Vishay IGBT Silicon “L Series”



Dual INT-A-PAK Low Profile

FEATURES

- Trench PT IGBT technology
- Low $V_{CE(on)}$
- Square RBSOA
- HEXFRED® antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al_2O_3 DBC
- UL approved file E78996 
- Designed for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT

| PRIMARY CHARACTERISTICS | |
|---|----------------------------|
| V_{CES} | 600 V |
| I_C DC at $T_C = 103\text{ }^\circ\text{C}$ | 400 A |
| $V_{CE(on)}$ (typical) at 400 A, $25\text{ }^\circ\text{C}$ | 1.30 V |
| Speed | DC to 1 kHz |
| Package | Dual INT-A-PAK low profile |
| Circuit configuration | Half bridge |

BENEFITS

- Increased operating efficiency
- Performance optimized as output inverter stage for TIG welding machines
- Direct mounting on heatsink
- Very low junction to case thermal resistance

| ABSOLUTE MAXIMUM RATINGS | | | | |
|--|----------------------|--|-------------|------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS |
| Collector to emitter voltage | V_{CES} | | 600 | V |
| Continuous collector current | I_C ⁽¹⁾ | $T_C = 25\text{ }^\circ\text{C}$ | 758 | A |
| | | $T_C = 80\text{ }^\circ\text{C}$ | 525 | |
| Pulsed collector current | I_{CM} | | n/a | |
| Clamped inductive load current | I_{LM} | | n/a | |
| Diode continuous forward current | I_F | $T_C = 25\text{ }^\circ\text{C}$ | 219 | |
| | | $T_C = 80\text{ }^\circ\text{C}$ | 145 | |
| Gate to emitter voltage | V_{GE} | | ± 20 | V |
| Maximum power dissipation (IGBT) | P_D | $T_C = 25\text{ }^\circ\text{C}$ | 1563 | W |
| | | $T_C = 80\text{ }^\circ\text{C}$ | 875 | |
| RMS isolation voltage | V_{ISOL} | Any terminal to case (V_{RMS} t = 1 s, $T_J = 25\text{ }^\circ\text{C}$) | 3500 | V |
| Operating junction and storage temperature range | T_J, T_{STG} | | -40 to +150 | $^\circ\text{C}$ |

Note

(1) Maximum continuous collector current must be limited to 500 A to do not exceed the maximum temperature of terminals



| ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | | | | |
|---|------------------------------|--|------|------|-----------|---------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Collector to emitter breakdown voltage | $V_{BR(CEs)}$ | $V_{GE} = 0\text{ V}, I_C = 500\text{ }\mu\text{A}$ | 600 | - | - | V |
| Collector to emitter voltage | $V_{CE(on)}$ | $V_{GE} = 15\text{ V}, I_C = 200\text{ A}$ | - | 1.13 | 1.24 | |
| | | $V_{GE} = 15\text{ V}, I_C = 400\text{ A}$ | - | 1.30 | 1.52 | |
| | | $V_{GE} = 15\text{ V}, I_C = 200\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.03 | - | |
| | | $V_{GE} = 15\text{ V}, I_C = 400\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.26 | - | |
| Gate threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}, I_C = 9.6\text{ mA}$ | 4.9 | 5.9 | 8.8 | |
| | | $V_{CE} = V_{GE}, I_C = 9.6\text{ mA}, T_J = 125\text{ }^\circ\text{C}$ | - | 3.2 | - | |
| Temperature coefficient of threshold voltage | $\Delta V_{GE(th)}/\Delta T$ | $V_{CE} = V_{GE}, I_C = 9.6\text{ mA}, (25\text{ }^\circ\text{C to } 125\text{ }^\circ\text{C})$ | - | -27 | - | mV/°C |
| Forward transconductance | g_{fe} | $V_{CE} = 20\text{ V}, I_C = 50\text{ A}$ | - | 74 | - | S |
| Transfer characteristics | V_{GE} | $V_{CE} = 20\text{ V}, I_C = 400\text{ A}$ | - | 10.7 | - | V |
| Collector to emitter leakage current | I_{CES} | $V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}$ | - | 5 | 200 | μA |
| | | $V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.5 | - | mA |
| Diode forward voltage drop | V_{FM} | $I_{FM} = 200\text{ A}$ | - | 1.42 | 1.55 | V |
| | | $I_{FM} = 400\text{ A}$ | - | 1.76 | 1.98 | |
| | | $I_{FM} = 200\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.43 | - | |
| | | $I_{FM} = 400\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.88 | - | |
| Gate to emitter leakage current | I_{GES} | $V_{GE} = \pm 20\text{ V}$ | - | - | ± 750 | nA |

| SWITCHING CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified) | | | | | | | |
|---|--------------|--|------------|------|------|---------------|----|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Turn-on switching energy | E_{on} | $I_C = 400\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = 15\text{ V}, R_g = 1.5\text{ }\Omega, L = 500\text{ }\mu\text{H}, T_J = 25\text{ }^\circ\text{C}$ | - | 6.3 | - | mJ | |
| Turn-off switching energy | E_{off} | | - | 45 | - | | |
| Total switching energy | E_{tot} | | - | 51.3 | - | | |
| Turn-on delay time | $t_{d(on)}$ | $I_C = 400\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = 15\text{ V}, R_g = 1.5\text{ }\Omega, L = 500\text{ }\mu\text{H}, T_J = 125\text{ }^\circ\text{C}$ | - | 633 | - | ns | |
| Rise time | t_r | | - | 254 | - | | |
| Turn-off delay time | $t_{d(off)}$ | | - | 715 | - | | |
| Fall time | t_f | | - | 490 | - | | |
| Turn-on switching loss | E_{on} | | - | 7.2 | - | | mJ |
| Turn-off switching loss | E_{off} | | - | 74 | - | | |
| Total switching loss | E_{tot} | | - | 81.2 | - | | |
| Turn-on delay time | $t_{d(on)}$ | $I_C = 400\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = 15\text{ V}, R_g = 1.5\text{ }\Omega, L = 500\text{ }\mu\text{H}, T_J = 125\text{ }^\circ\text{C}$ | - | 595 | - | ns | |
| Rise time | t_r | | - | 250 | - | | |
| Turn-off delay time | $t_{d(off)}$ | | - | 950 | - | | |
| Fall time | t_f | | - | 865 | - | | |
| Reverse bias safe operating area | RBSOA | $T_J = 150\text{ }^\circ\text{C}, I_C = \text{n/a}, V_{CC} = 300\text{ V}, V_P = 600\text{ V}, R_g = 1.5\text{ }\Omega, V_{GE} = 15\text{ V to } 0\text{ V}, L = 500\text{ }\mu\text{H}$ | Fullsquare | | | | |
| Diode reverse recovery time | t_{rr} | $I_F = 400\text{ A}, R_g = 1.5\text{ }\Omega, V_{CC} = 300\text{ V}, T_J = 25\text{ }^\circ\text{C}$ | - | 123 | - | ns | |
| Diode peak reverse current | I_{rr} | | - | 107 | - | A | |
| Diode recovery charge | Q_{rr} | | - | 8.1 | - | μC | |
| Diode reverse recovery time | t_{rr} | $I_F = 400\text{ A}, R_g = 1.5\text{ }\Omega, V_{CC} = 300\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | 167 | - | ns | |
| Diode peak reverse current | I_{rr} | | - | 140 | - | A | |
| Diode recovery charge | Q_{rr} | | - | 14.7 | - | μC | |



| THERMAL AND MECHANICAL SPECIFICATIONS | | | | | |
|--|------------------------------------|------|------|------|-------|
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNITS |
| Operating junction and storage temperature range | T_J, T_{Stg} | -40 | - | 150 | °C |
| Junction to case per leg | IGBT | - | - | 0.08 | °C/W |
| | Diode | - | - | 0.4 | |
| Case to sink per module | R_{thCS} | - | 0.05 | - | |
| Mounting torque | case to heatsink: M6 screw | 4 | - | 6 | Nm |
| | case to terminal 1, 2, 3: M5 screw | 2 | - | 5 | |
| Weight | | - | 270 | - | g |

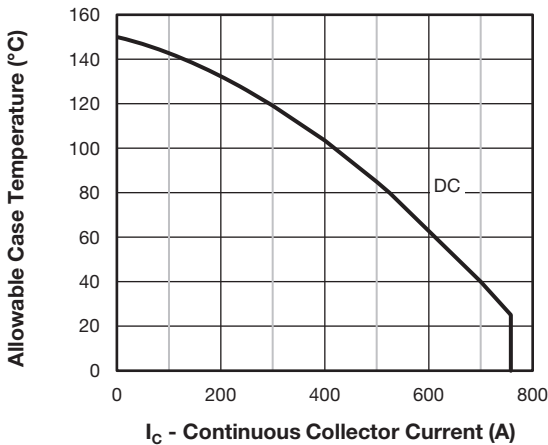


Fig. 1 - Maximum IGBT Continuous Collector Current vs. Case Temperature

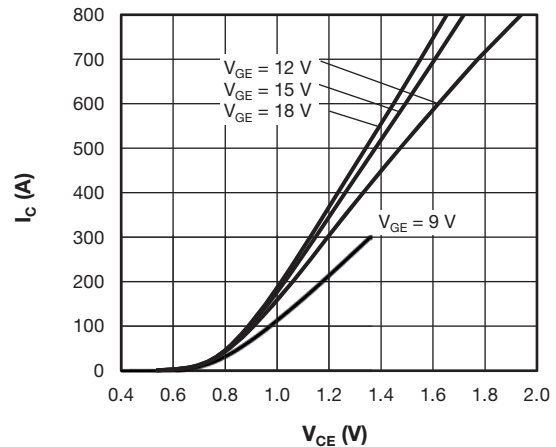


Fig. 3 - Typical IGBT Output Characteristics, $T_J = 125$ °C

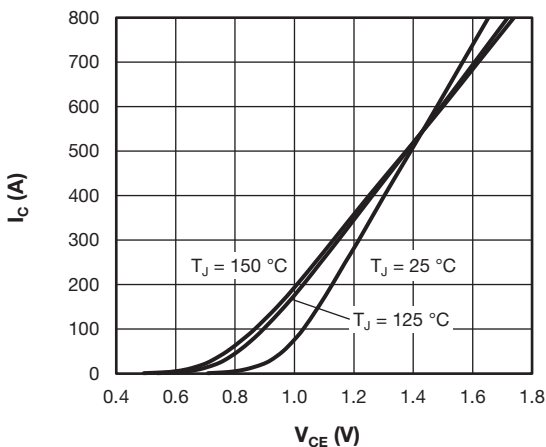


Fig. 2 - Typical IGBT Output Characteristics, $V_{GE} = 15$ V

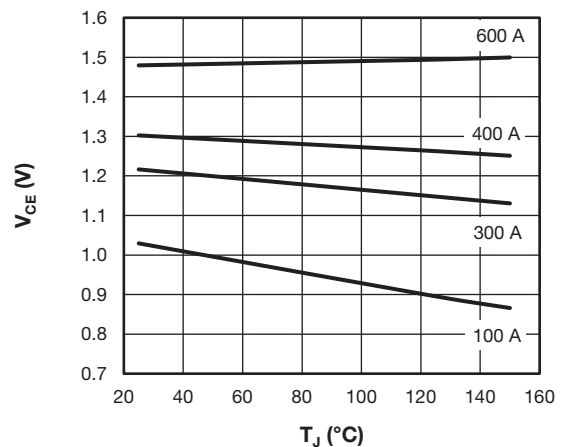


Fig. 4 - Collector to Emitter Voltage vs. Junction Temperature

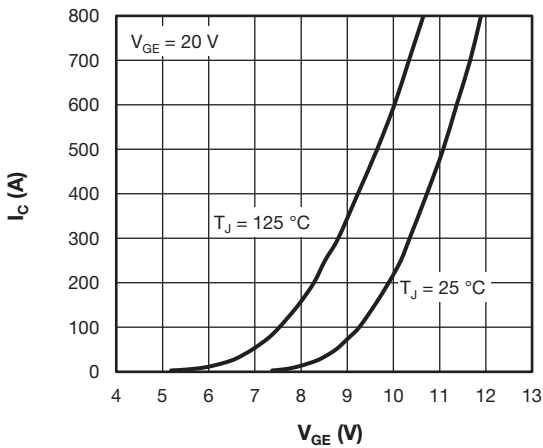


Fig. 5 - Typical IGBT Transfer Characteristics

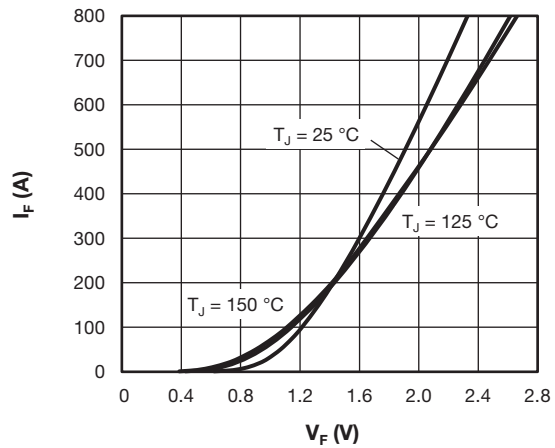


Fig. 8 - Typical Diode Forward Characteristics

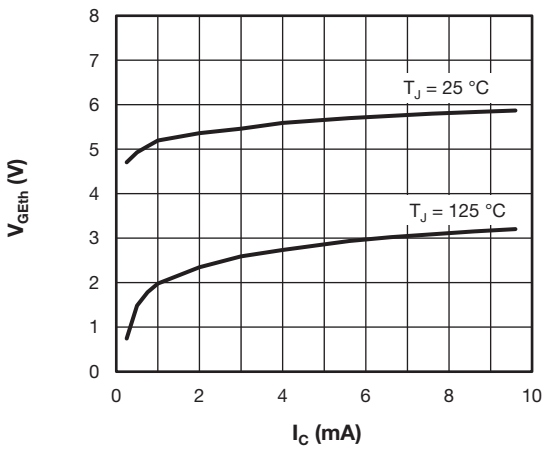


Fig. 6 - Typical IGBT Gate Threshold Voltage

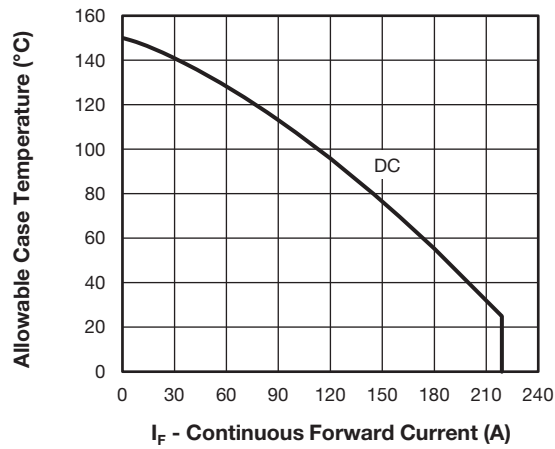


Fig. 9 - Maximum Diode Continuous Forward Current vs. Case Temperature

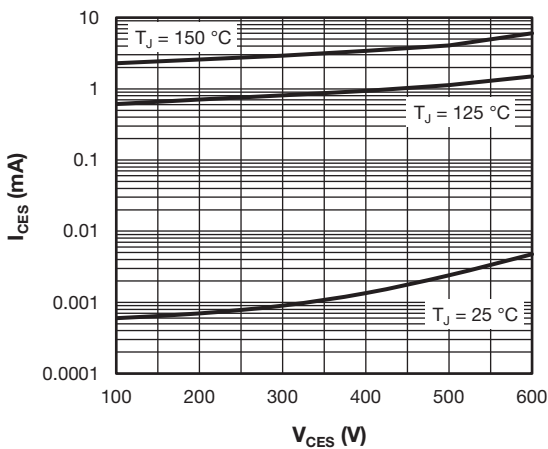


Fig. 7 - Typical IGBT Zero Gate Voltage Collector Current

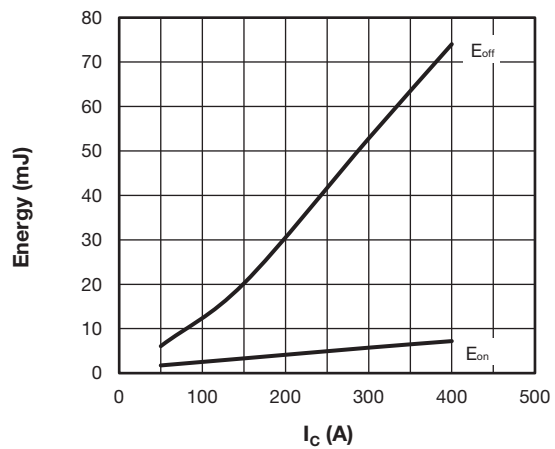


Fig. 10 - Typical IGBT Energy Loss vs. I_c
 $T_J = 125\text{ }^\circ\text{C}$, $V_{CC} = 300\text{ V}$, $R_g = 1.5\ \Omega$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

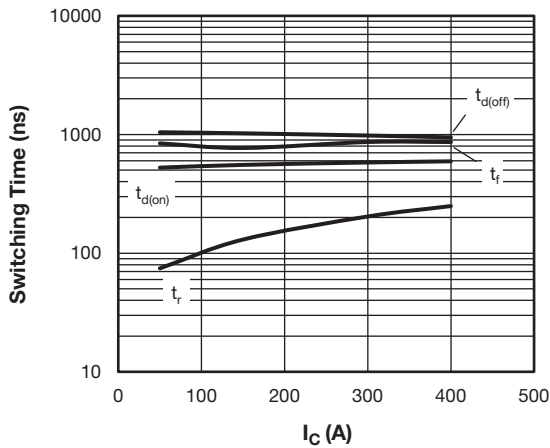


Fig. 11 - Typical IGBT Switching Time vs. I_C
 $T_J = 125^\circ\text{C}$, $V_{CC} = 300\text{ V}$, $R_g = 1.5\ \Omega$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

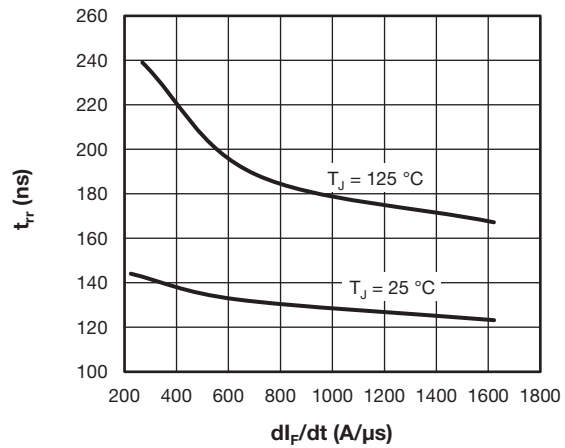


Fig. 14 - Typical Diode Reverse Recovery Time vs. di_F/dt
 $V_{CC} = 300\text{ V}$, $I_F = 400\text{ A}$

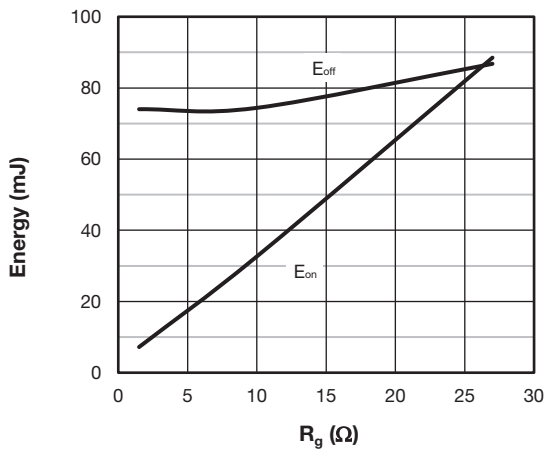


Fig. 12 - Typical IGBT Energy Loss vs. R_g
 $T_J = 125^\circ\text{C}$, $V_{CC} = 300\text{ V}$, $I_C = 400\text{ A}$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

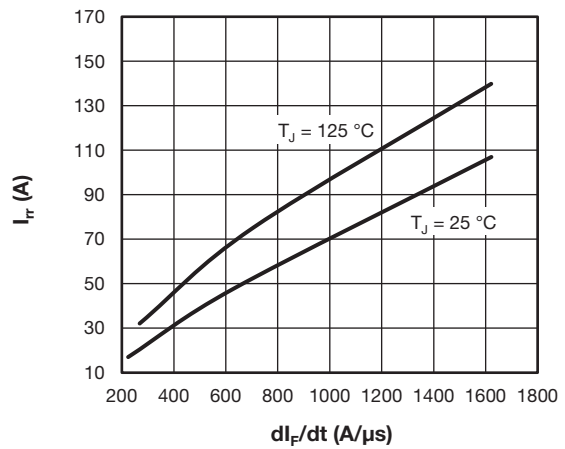


Fig. 15 - Typical Diode Reverse Recovery Current vs. di_F/dt
 $V_{CC} = 300\text{ V}$, $I_F = 400\text{ A}$

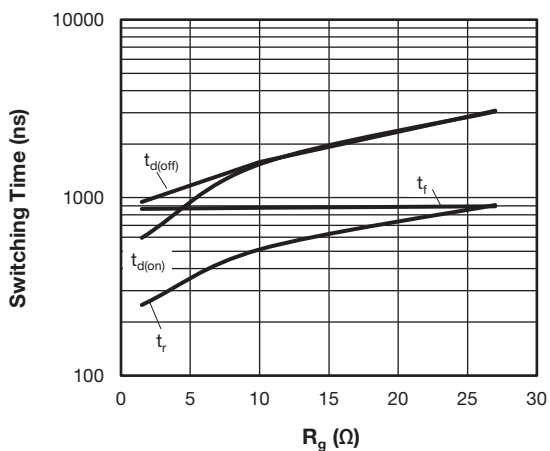


Fig. 13 - Typical IGBT Switching Time vs. R_g
 $T_J = 125^\circ\text{C}$, $V_{CC} = 300\text{ V}$, $I_C = 400\text{ A}$, $V_{GE} = 15\text{ V}$, $L = 500\ \mu\text{H}$

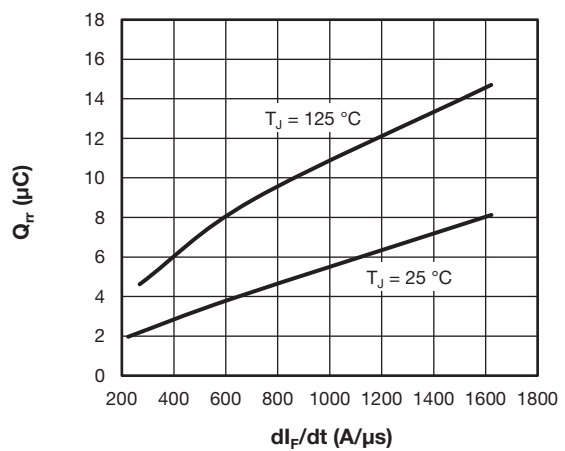


Fig. 16 - Typical Diode Reverse Recovery Charge vs. di_F/dt
 $V_{CC} = 300\text{ V}$, $I_F = 400\text{ A}$

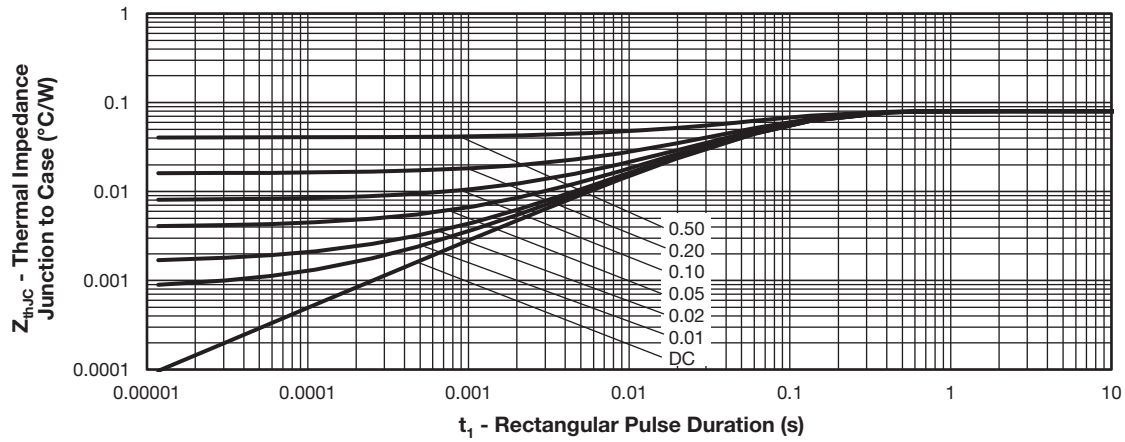


Fig. 17 - Maximum Thermal Impedance Z_{thJC} Characteristics - (IGBT)

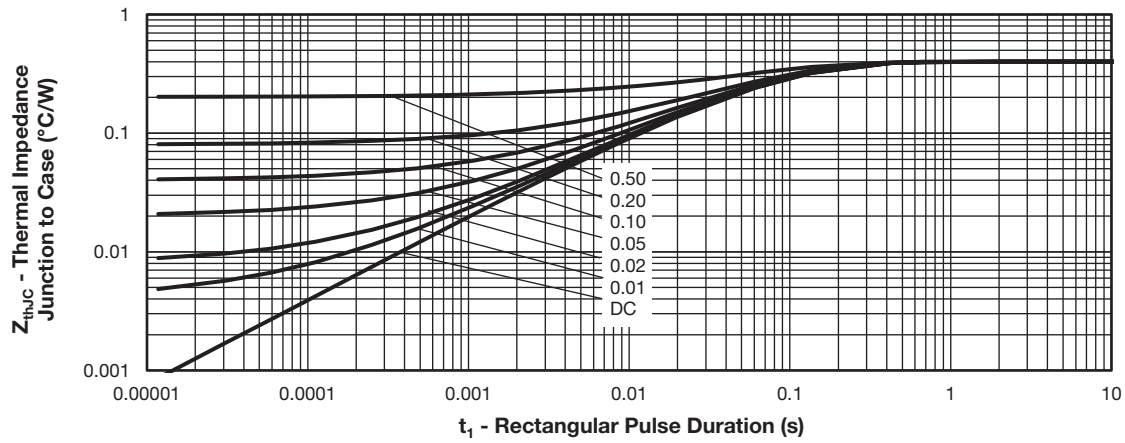


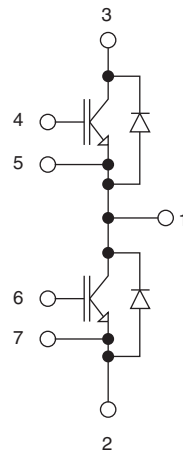
Fig. 18 - Maximum Thermal Impedance Z_{thJC} Characteristics - (Diode)

ORDERING INFORMATION TABLE

| | | | | | | | | |
|-------------|------------|----------|----------|------------|----------|----------|-----------|----------|
| Device code | VS- | G | P | 400 | T | D | 60 | S |
| | ① | ② | ③ | ④ | ⑤ | ⑥ | ⑦ | ⑧ |

- 1 - Vishay Semiconductors product
- 2 - Insulated gate bipolar transistor (IGBT)
- 3 - P = trench PT IGBT technology
- 4 - Current rating (400 = 400 A)
- 5 - Circuit configuration (T = half bridge)
- 6 - Package indicator (D = dual INT-A-PAK low profile)
- 7 - Voltage rating (60 = 600 V)
- 8 - Speed / type (S = standard speed IGBT)

CIRCUIT CONFIGURATION



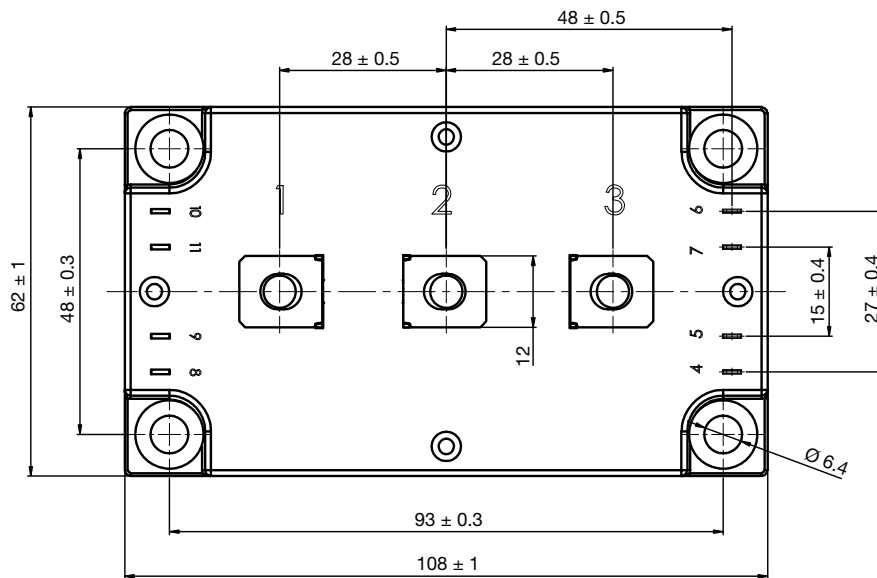
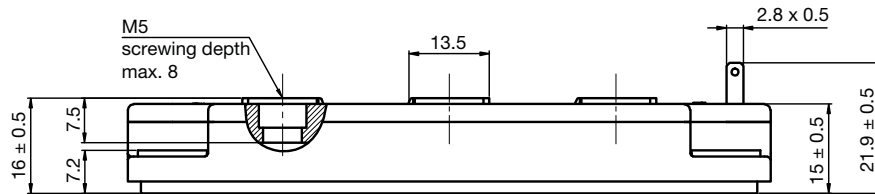
LINKS TO RELATED DOCUMENTS

| | |
|------------|--|
| Dimensions | www.vishay.com/doc?95435 |
|------------|--|



Dual INT-A-PAK Low Profile

DIMENSIONS in millimeters





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